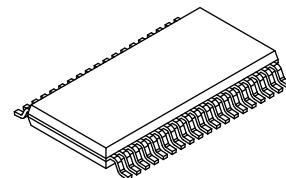
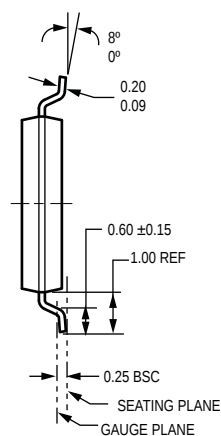
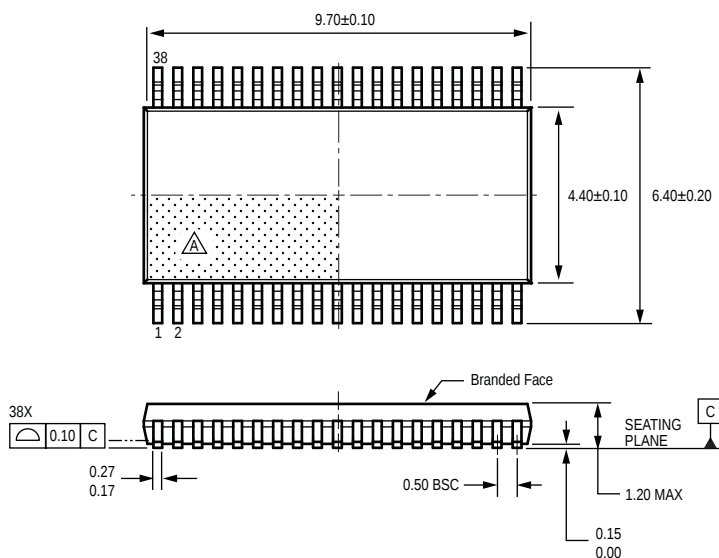


Designator: LD

Type: 38-pin, 0.50 mm pin pitch TSSOP



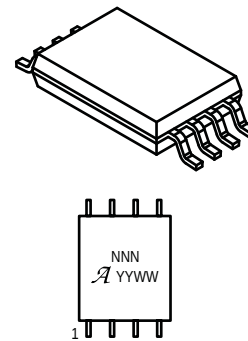
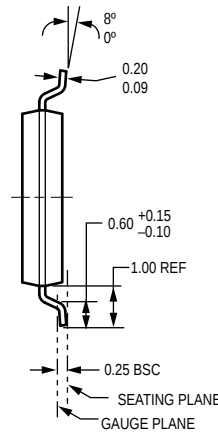
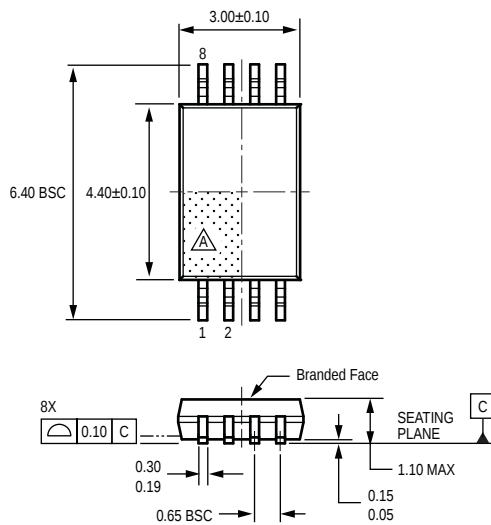
Standard Branding Reference View

N = Device part number
A = Supplier emblem
Y = Last two digits of year of manufacture
W = Week of manufacture
L = Lot number

For Reference Only; not for tooling use (reference MO-153 BD-1)
Dimensions in millimeters
Dimensions exclusive of mold flash, gate burrs, and dambar protrusions
Exact case and lead configuration at supplier discretion within limits shown

Terminal #1 mark area
Branding scale and appearance at supplier discretion

Designator: *LE* Type: 8-pin, 0.65 mm pin pitch TSSOP



 Standard Branding Reference View

N = Last 3 digits of device part number
A = Supplier emblem
Y = Last two digits of year of manufacture
W = Week of manufacture
Branding scale and appearance at supplier discretion

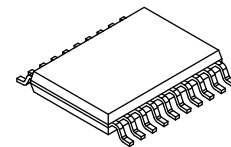
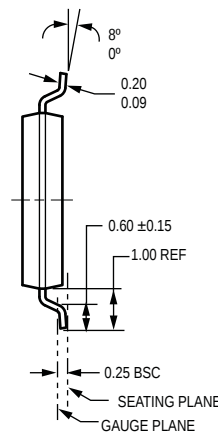
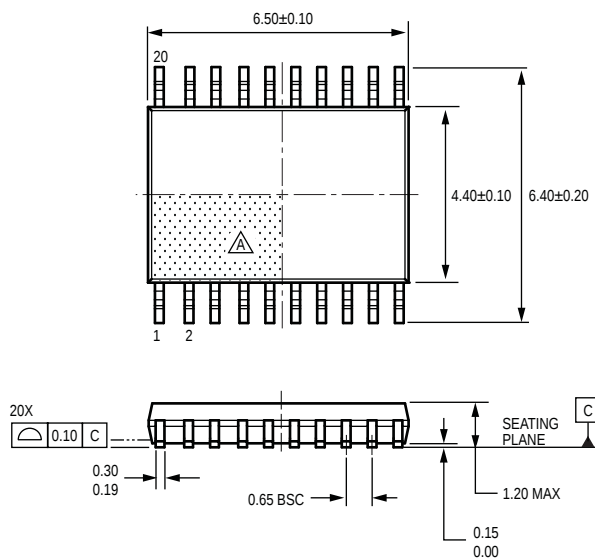
For Reference Only; not for tooling use (reference MO-153 AA)
Dimensions in millimeters
Dimensions exclusive of mold flash, gate burrs, and dambar protrusions
Exact case and lead configuration at supplier discretion within limits shown

 Terminal #1 mark area

 Branding scale and appearance at supplier discretion

Designator: LE

Type: 20-pin, 0.65 mm pin pitch TSSOP



Standard Branding Reference View

N = Device part number
A = Supplier emblem
Y = Last two digits of year of manufacture
W = Week of manufacture
L = Characters 5-8 of lot number

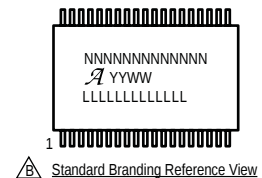
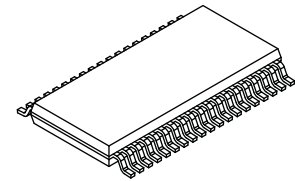
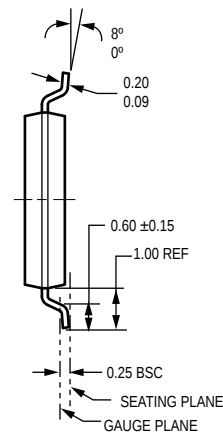
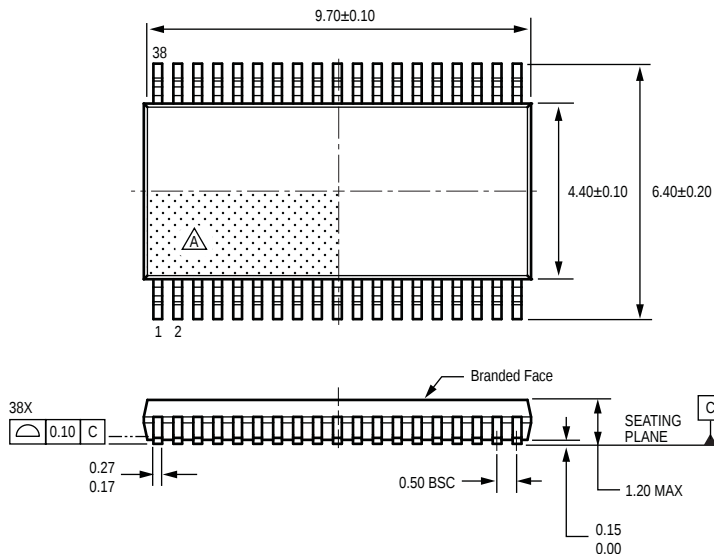
For Reference Only; not for tooling use (reference MO-153 AC)
Dimensions in millimeters
Dimensions exclusive of mold flash, gate burrs, and dambar protrusions
Exact case and lead configuration at supplier discretion within limits shown

Terminal #1 mark area

Branding scale and appearance at supplier discretion

Designator: LG

Type: 38-pin, 0.50 mm pin pitch TSSOP with internally fused pins for thermal dissipation



N = Device part number
 A = Supplier emblem
 Y = Last two digits of year of manufacture
 W = Week of manufacture
 L = Lot number

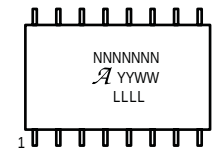
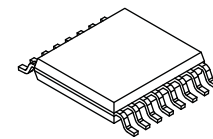
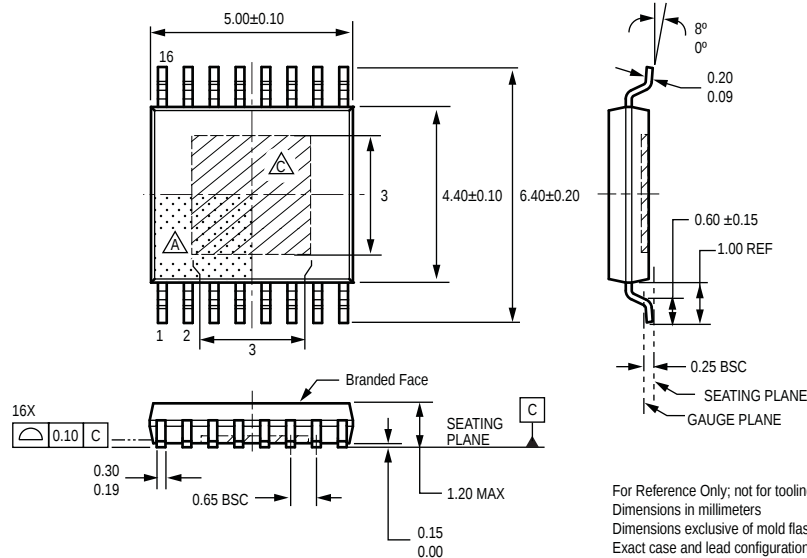
For Reference Only; not for tooling use (reference MO-153 BD-1)
 Dimensions in millimeters
 Dimensions exclusive of mold flash, gate burrs, and dambar protrusions
 Exact case and lead configuration at supplier discretion within limits shown

 Terminal #1 mark area
 Branding scale and appearance at supplier discretion

Internal configuration of fused pins is device-dependent

Designator: LP

Type: 16-pin, 0.65 mm pin pitch TSSOP with exposed thermal pad



Standard Branding Reference View

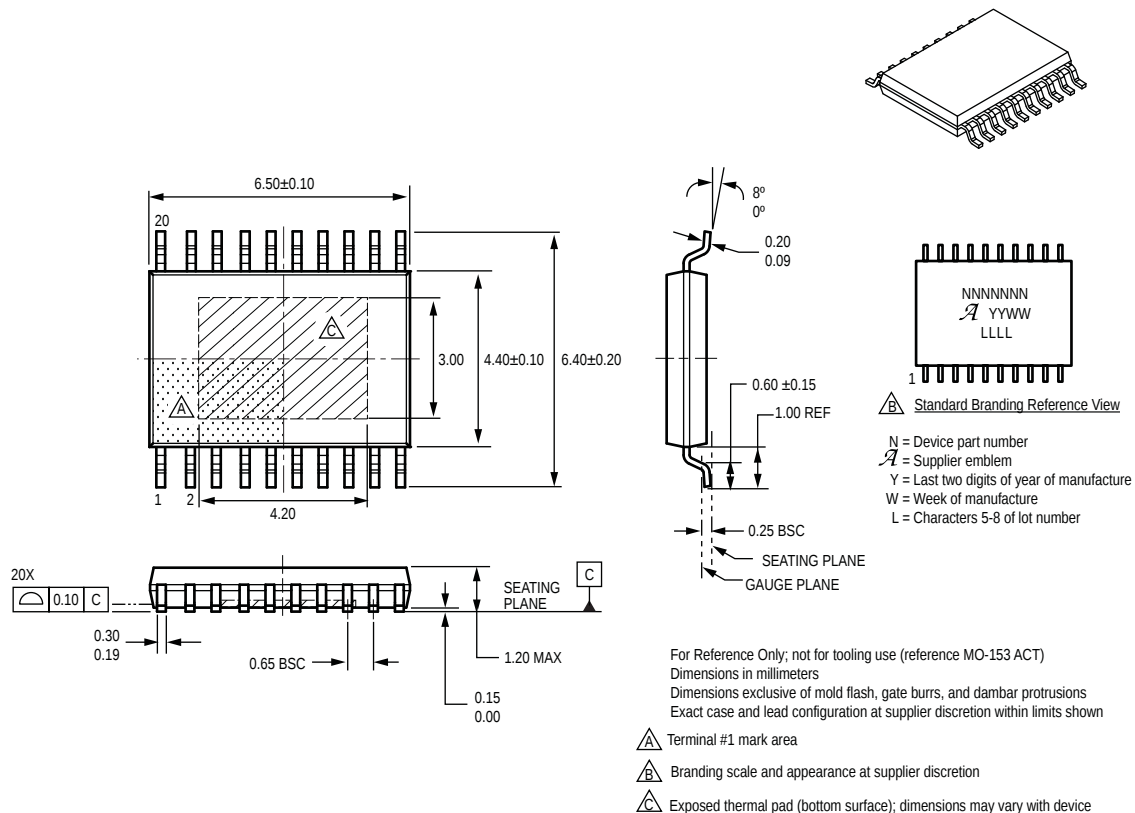
N = Device part number
 A = Supplier emblem
 Y = Last two digits of year of manufacture
 W = Week of manufacture
 L = Characters 5-8 of lot number

For Reference Only; not for tooling use (reference MO-153 ABT)
 Dimensions in millimeters
 Dimensions exclusive of mold flash, gate burrs, and dambar protrusions
 Exact case and lead configuration at supplier discretion within limits shown

-  Terminal #1 mark area
-  Branding scale and appearance at supplier discretion
-  Exposed thermal pad (bottom surface); dimensions may vary with device

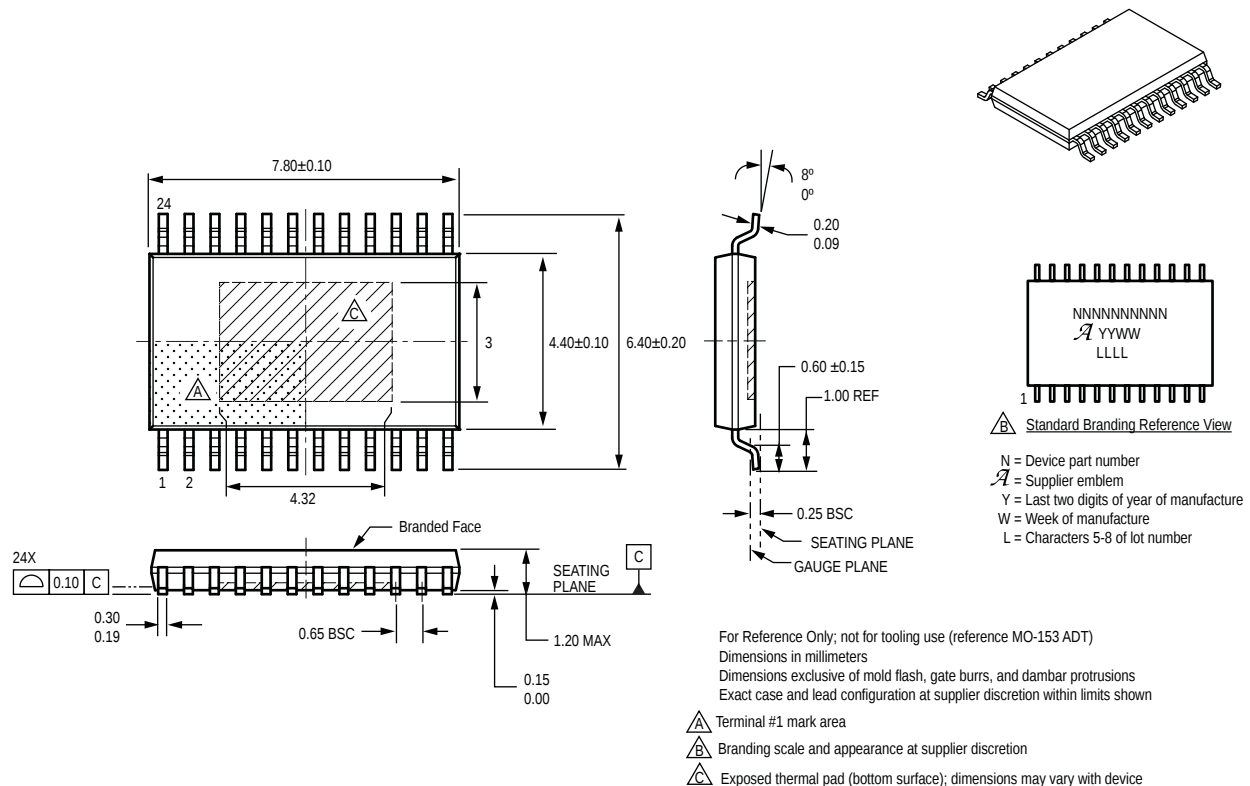
Designator: LP

Type: 20-pin, 0.65 mm pin pitch TSSOP with exposed thermal pad



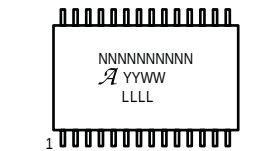
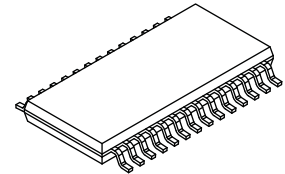
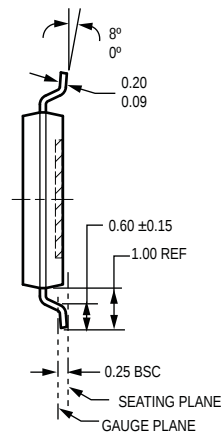
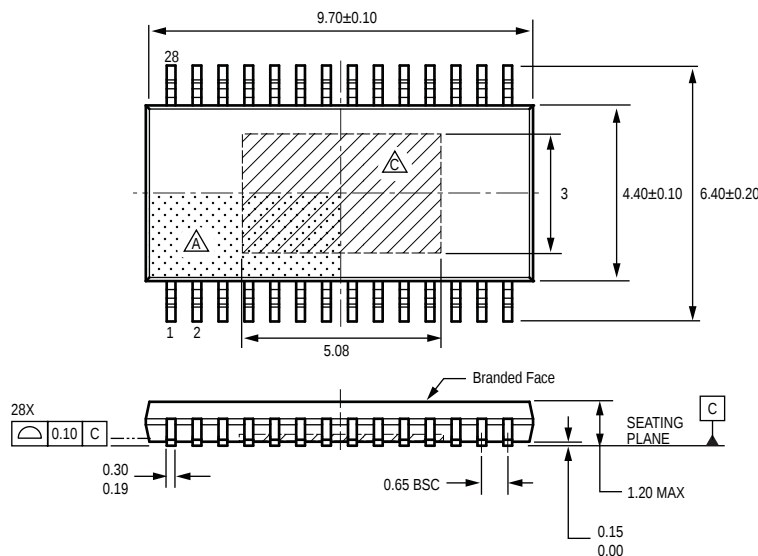
Designator: LP

Type: 24-pin, 0.65 mm pin pitch TSSOP with exposed thermal pad



Designator: LP

Type: 28-pin, 0.65 mm pin pitch TSSOP with exposed thermal pad



B Standard Branding Reference View

N = Device part number
A = Supplier emblem
Y = Last two digits of year of manufacture
W = Week of manufacture
L = Characters 5-8 of lot number

For Reference Only; not for tooling use (reference MO-153 AET)
Dimensions in millimeters
Dimensions exclusive of mold flash, gate burrs, and dambar protrusions
Exact case and lead configuration at supplier discretion within limits shown

- A** Terminal #1 mark area
- B** Branding scale and appearance at supplier discretion
- C** Exposed thermal pad (bottom surface); dimensions may vary with device